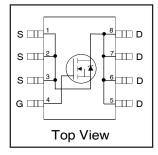
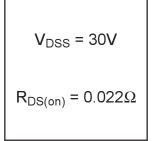
International Rectifier

IRF7403PbF

HEXFET® Power MOSFET

- Generation V Technology
- Ultra Low On-Resistance
- N-Channel Mosfet
- Surface Mount
- Available in Tape & Reel
- Dynamic dv/dt Rating
- Fast Switching
- Lead-Free

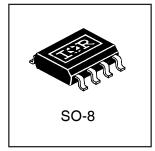




Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics and multiple-die capability making it ideal in a variety of power applications. With these improvements, multiple devices can be used in an application with dramatically reduced board space. The package is designed for vapor phase, infra red, or wave soldering techniques. Power dissipation of greater than 0.8W is possible in a typical PCB mount application.



Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _A = 25°C	10 Sec. Pulsed Drain Current, V _{GS} @ 10V	9.7	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	8.5	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	5.4	A
I _{DM}	Pulsed Drain Current ①	34	
P _D @T _A = 25°C	Power Dissipation	2.5	W
	Linear Derating Factor	0.02	W/°C
V_{GS}	Gate-to-Source Voltage	±20	V
dv/dt	Peak Diode Recovery dv/dt ②	5.0	V/ns
$T_{J,}T_{STG}$	Junction and Storage Temperature Range	-55 to + 150	℃

Thermal Resistance Ratings

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient®		50	°C/W

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ	Max.	Units	Conditions
\ /			ryp.	IVIAX.		
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	30			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.024		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(ON)}	Static Drain-to-Source On-Resistance			0.022	Ω	$V_{GS} = 10V, I_D = 4.0A$ ③
TUS(ON)	Statio Brain to Godine On Neolotanice			0.035	35	$V_{GS} = 4.5V, I_D = 3.4A$ ③
V _{GS(th)}	Gate Threshold Voltage	1.0			V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
g _{fs}	Forward Transconductance	8.4			S	$V_{DS} = 15V, I_{D} = 4.0A$
	Dunin to Course Leakers Comment			1.0	μA	$V_{DS} = 24V, V_{GS} = 0V$
I _{DSS}	Drain-to-Source Leakage Current			25	μΑ	$V_{DS} = 24V$, $V_{GS} = 0V$, $T_{J} = 125$ °C
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
1GSS	Gate-to-Source Reverse Leakage			-100	ш	$V_{GS} = -20V$
Qg	Total Gate Charge			57		I _D = 4.0A
Q _{gs}	Gate-to-Source Charge			6.8	nC	V _{DS} = 24V
Q_{gd}	Gate-to-Drain ("Miller") Charge			18		V_{GS} = 10V, See Fig. 6 and 12 ③
t _{d(on)}	Turn-On Delay Time		10			$V_{DD} = 15V$
t _r	Rise Time		37		no	I _D = 4.0A
t _{d(off)}	Turn-Off Delay Time		42		ns	$R_G = 6.0\Omega$
t _f	Fall Time		40			R_D = 3.7 Ω , See Fig. 10 ③
L _D	Internal Drain Inductance		2.5		nH	Between lead tip
L _S	Internal Source Inductance		4.0			and center of die contact
C _{iss}	Input Capacitance		1200			V _{GS} = 0V
Coss	Output Capacitance		450		pF	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		160			f = 1.0MHz, See Fig. 5

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current (Body Diode)	_		3.1	А	MOSFET symbol showing the
I _{SM}	Pulsed Source Current (Body Diode) ①	_		34	, A	integral reverse p-n junction diode.
V_{SD}	Diode Forward Voltage			1.0	V	$T_J = 25$ °C, $I_S = 2.0$ A, $V_{GS} = 0$ V ③
t _{rr}	Reverse Recovery Time		52	78	ns	$T_J = 25$ °C, $I_F = 4.0$ A
Q _{rr}	Reverse RecoveryCharge		93	140	nC	di/dt = 100A/µs ③
ton	Forward Turn-On Time Intrinsic turn-on time is negligible (turn-on is dominated				egligible (turn-on is dominated by L _S +L _D)	

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\begin{tabular}{ll} @ & I_{SD} \leq 4.0A, \ di/dt \leq 180A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \\ & T_{J} \leq 150 ^{\circ} C \end{tabular}$
- 4 Surface mounted on FR-4 board, $t \leq 10$ sec.

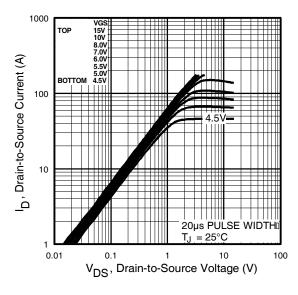


Fig 1. Typical Output Characteristics

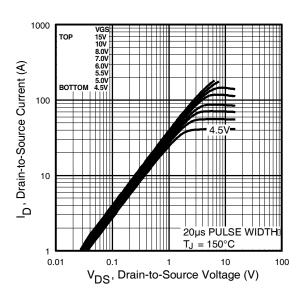


Fig 2. Typical Output Characteristics

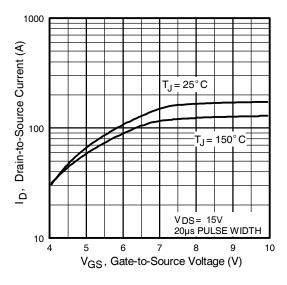


Fig 3. Typical Transfer Characteristics

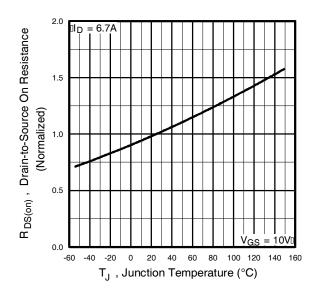


Fig 4. Normalized On-Resistance Vs. Temperature

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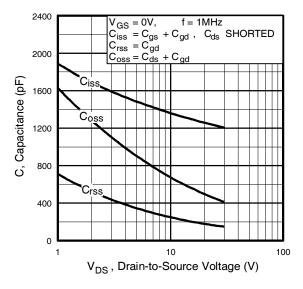


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

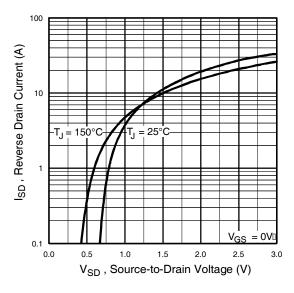


Fig 7. Typical Source-Drain Diode Forward Voltage

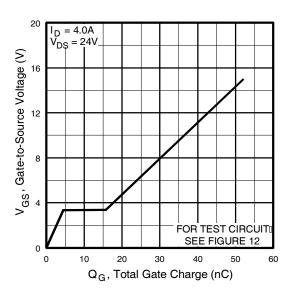


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

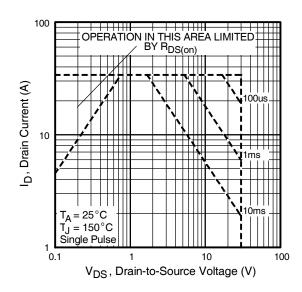


Fig 8. Maximum Safe Operating Area

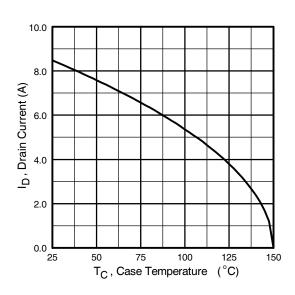


Fig 9. Maximum Drain Current Vs.
Ambient Temperature

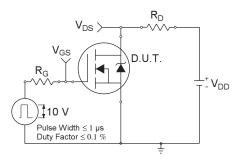


Fig 10a. Switching Time Test Circuit

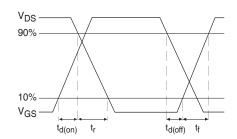


Fig 10b. Switching Time Waveforms

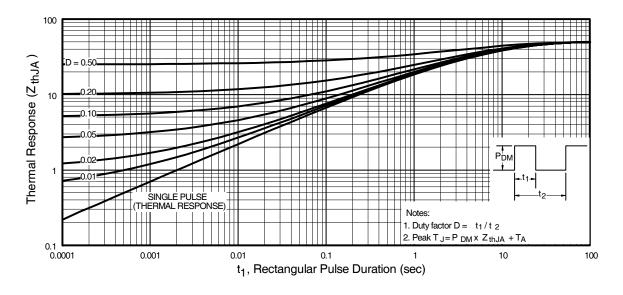


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

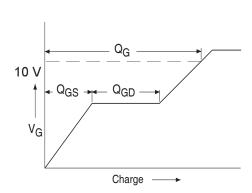


Fig 12a. Basic Gate Charge Waveform

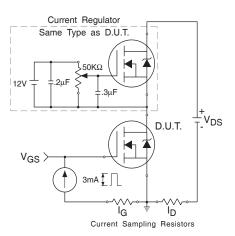
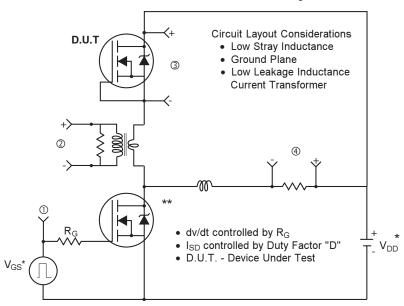
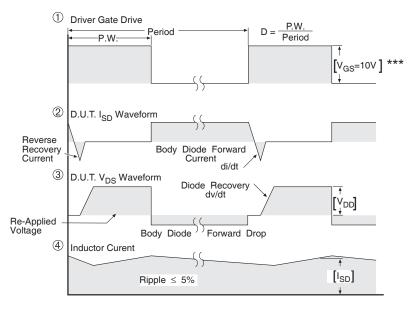


Fig 12b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



- * Reverse Polarity for P-Channel
- ** Use P-Channel Driver for P-Channel Measurements



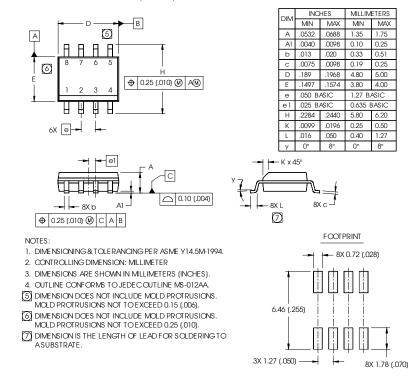
*** V_{GS} = 5.0V for Logic Level and 3V Drive Devices

Fig 13. For N-Channel HEXFETS

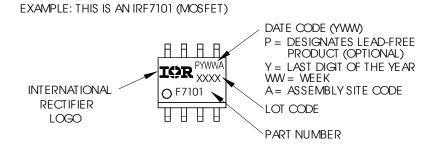
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SO-8 Package Outline

Dimensions are shown in milimeters (inches)

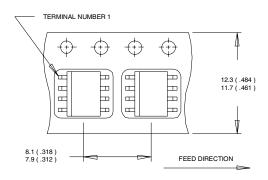


SO-8 Part Marking Information (Lead-Free)



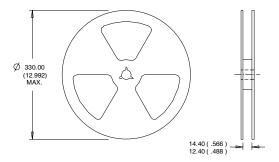
SO-8 Tape and Reel

Dimensions are shown in milimeters (inches)



NOTES:

- CONTROLLING DIMENSION: MILLIMETER.
 ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
 OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES:
 1. CONTROLLING DIMENSION: MILLIMETER.
 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

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